RoHS COMPLIANT

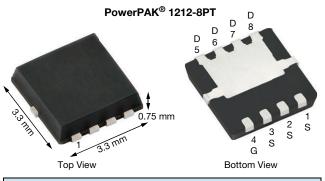
HALOGEN

FREE

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Vishay Siliconix

P-Channel 20 V (D-S) MOSFET



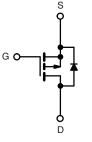
PRODUCT SUMMARY	
V _{DS} (V)	-20
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0038
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0050
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.0090
Q _g typ. (nC)	48
I _D (A) ^a	-104
Configuration	Single

FEATURES

- TrenchFET[®] Gen IV p-channel power MOSFET
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Adaptor switch
- · Battery switch
- Load switch



P-Channel MOSFET

ORDERING INFORMATION

Package	PowerPAK 1212-8PT
Lead (Pb)-free and halogen-free	Si7615BDN-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \,^{\circ}C$, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-20	V	
Gate-source voltage		V _{GS}	± 12	v	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-104 ^a		
	T _C = 70 °C		-83 ^a		
	T _A = 25 °C		-29 b, c		
	T _A = 70 °C		-23 ^{b, c}	•	
Pulsed drain current (t = 100 µs)		I _{DM}	-150	Α	
Continuous source-drain diode current	T _C = 25 °C		-60 ^a		
	T _A = 25 °C	– I _S –	-4.7 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-22		
Single pulse avalanche energy		E _{AS}	24	mJ	
Maximum power dissipation	T _C = 25 °C		66		
	T _C = 70 °C		42	w	
	T _A = 25 °C	P _D	5.2 ^{b, c}	vv	
	T _A = 70 °C	1 [3.3 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to 150	°C	
Soldering recommendations (peak temperature) ^c			260	-0	

THERMAL RESISTANCE RATINGS PARAMETER SYMBOL **TYPICAL** MAXIMUM UNIT Maximum junction-to-ambient b, f $t \le 10 s$ 19 24 R_{thJA} °C/W 1.3 1.9 Maximum junction-to-case (drain) Steady state R_{thJC}

Notes a. $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8PT is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 60 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-15	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μΑ	-	3.4	-		
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250 μA	-0.4	-	-1.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	± 100	nA	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
		V _{DS} = -20 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30	-	-	Α	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -20 A	-	0.0029	0.0038	Ω	
		V _{GS} = -4.5 V, I _D = -15 A	-	0.0037	0.0050		
	- (-)	V _{GS} = -2.5 V, I _D = -5 A	-	0.0060	0.0090		
Forward transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -30 A	-	97	-	S	
Dynamic ^b				•	•		
Input capacitance	C _{iss}		-	4890	-	pF	
Output capacitance	C _{oss}	$V_{DS} = -10 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$	-	735	-		
Reverse transfer capacitance	C _{rss}		-	705	-		
-		$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -15 \text{ A}$	-	103	155	- nC	
Total gate charge	Qg		-	48	72		
Gate-source charge	Q _{qs}	V _{DS} = -10 V, V _{GS} = -4.5 V, I _D = -15 A	-	11	-		
Gate-drain charge	Q _{qd}		-	12	-		
Gate resistance	R _q	f = 1 MHz	0.7	3.6	7.2	Ω	
Turn-on delay time	t _{d(on)}		-	25	50	-	
Rise time	t _r	V _{DD} = -10 V, R _I = 1 Ω, I _D ≅ -10 A,	-	25	50		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	90	180		
Fall time	t _f		-	50	100		
Turn-on delay time	t _{d(on)}		-	10	20	ns	
Rise time	tr	V_{DD} = -10 V, R_{L} = 1 Ω, I_{D} ≅ -10 A,	-	5	10	-	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	85	170		
Fall time	t _f		-	30	60		
Drain-Source Body Diode Characteristi	cs			<u> </u>	•		
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	60		
Pulse diode forward current	I _{SM}		-	-	150	- A	
Body diode voltage	V _{SD}	I _S = -5 A, V _{GS} = 0 V	-	0.74	-1.1	V	
Body diode reverse recovery time	t _{rr}		-	25	50	ns	
Body diode reverse recovery charge	Q _{rr}		-	13	26	nC	
Reverse recovery fall time	ta	I _F = -10 A, di/dt = 100 A/μs, T _J = 25 °C	-	13	-	ns	
Reverse recovery rise time	t _b		-	12	-		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

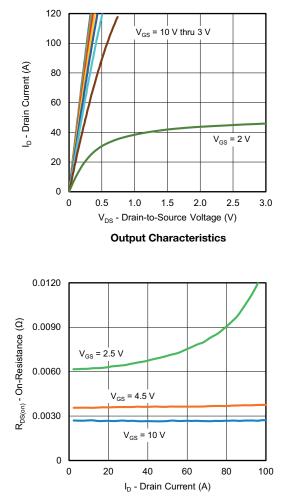
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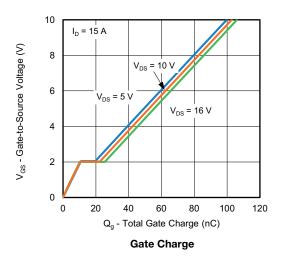


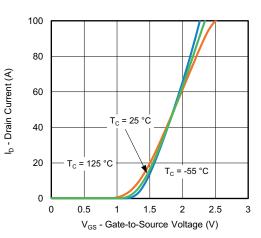
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

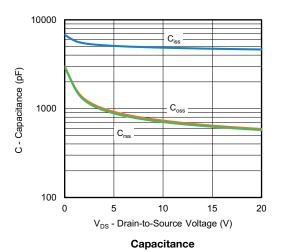


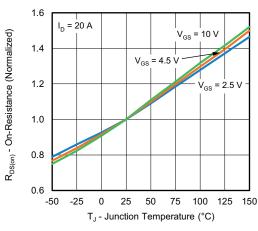
On-Resistance vs. Drain Current and Gate Voltage





Transfer Characteristics





On-Resistance vs. Junction Temperature

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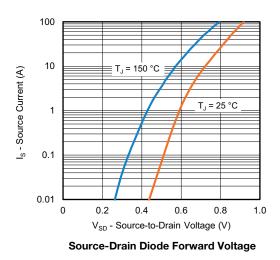
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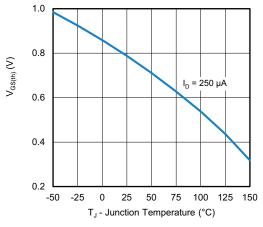
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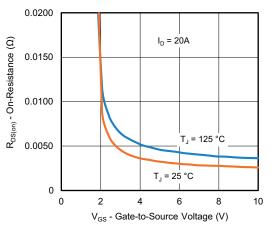
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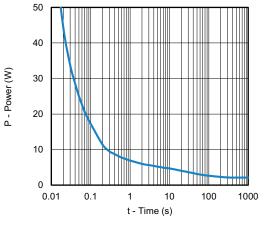




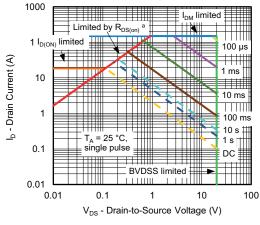
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

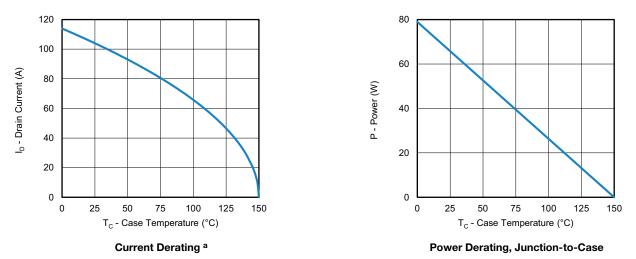
a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

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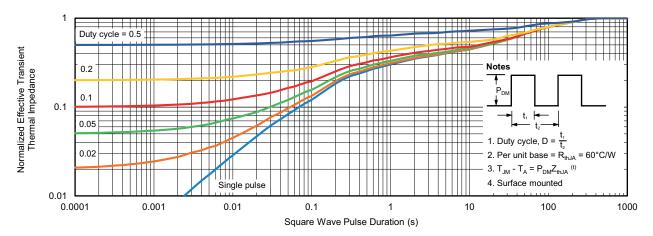
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

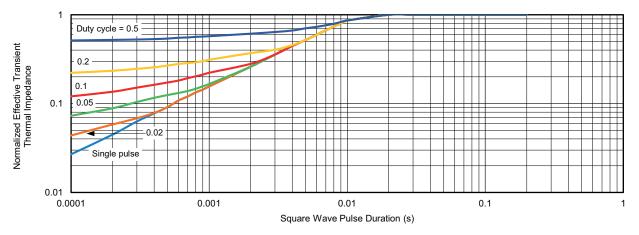


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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